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Sheet	1	of	1
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Complete if Known

Application Number	10/043,627
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Filing Date	1/9/2002
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First Named Inventor	Chen et al
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Group Art Unit	1614
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Examiner Name	Unknown
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Attorney Docket Number	PH-7211
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U.S. PATENT DOCUMENTS

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FOREIGN PATENT DOCUMENTS

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Examiner
Signature

Date Considered

8/15/03

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